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Washington, D.C. 2023

c mansmitted herewith for filing is the Patent Application of:

ptor: MOU SHIUNG LIN, MING TA LEI, CHUEN JYE LIN

A STRUCTURE AND MANUFACTURING METHOD OF A CHIP SCALE PACKAGE



Enclosed are:

à. Ē

X = 9 sheets of drawing(s) - formal.

An assignment of the invention to .MEGIC Corp.

An associate power of attorney

Applicant claims small entity status

 \mathbf{X} Request & Certification under 35 USC 122(b)(2)(b)(i)

The $\frac{\pi}{2}$ iling fee has been calculated as shown below:

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BASIC FEE	><		><	\$ <i>35</i> 5.
TOTAL CLAIMS	24 -20=	4	x 9. =	\$ 36.
INDEP CLAIMS	2 -3=	0	x =	\$ 0.
MULTIPLE DEPENDENT CLAIM PRESENTED + 260 =				
		SI	JB TOTAL	\$.39 L
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		T	OTAL	s 431.

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REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

First Named Inventor		1/2 5/2
Title	A Structu Method of	reand Hanutacturing A ChipScale Parkage
Atty Docket Number		3

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

4/18/01 Date

Signature

Stephen B. Ackerman
Typed or printed name 37,76,

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

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